



PRODUCT DATASHEET



- PLCC6 with IC
- 1212 IC 0.75t
- Red/Green/Blue

N0M66S12IC





APPLICATIONS:

- **Automotive Ambient Lightings** •
- Telecommunication
- Status Indicator
- Home Appliance •
- **Decoration Lighting**
- Full Colour LED Strip •
- Gaming Device •
- Guardrail Tube •
- Indoor Display Screen

1212 IC-Integrated Compliant



FEATURES:

- Package: PLCC 6-Pins EIA STD Package with Integrated IC
- Forward Current: 3.63/3.63/3.63mA*
- Luminous Intensity (typ.): 460mcd mixed white
- Colour: Red/Green/Blue
- **IC Feature:**
 - \checkmark Single data line employing a communication protocol that utilizes zero-return codes.
 - Built-in high-precision and high-stability oscillator. The serial data frequency is adjustable up to 1300kHz.
 - Data output re-shaping for accurate and long-distance ✓ transmission.
 - \checkmark Built-in overvoltage protection.
 - \checkmark 2 data input ports to allow breakpoint jumping.
- Pixel: Supports Support 65536 levels (16bits) grayscale . adjustment of each R/G/B single channel. Maximum 12mA of constant current output for each R/G/B channel with 5 bits dimming level.
- Soldering methods: IR Reflow soldering
- MSL Level: acc. to JEDEC Level 3
- Packing: 8mm tape with max.4000pcs/reel, ø180mm (7")

* in order of Red/Green/Blue



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

| Parameter | Symbol | Ratings | Unit |
|---|-----------------|-----------|------|
| Forward Current | lf | 12 | mA |
| IC Power Supply Voltage | V _{DD} | 4.0~7.5 | V |
| R/G/B Output Port Withstand Voltage | Vds | max. 9 | V |
| IC Input Voltage | Vı | -0.5~+5.5 | V |
| Operating Temperature | Topr | -40~+105 | °C |
| Storage Temperature | Тѕтб | -40~+105 | °C |
| Junction Temperature | Tj | 125 | °C |
| Soldering Temperature | T _{SD} | 260 | °C |
| ESD Withstand Voltage acc. ANSI/ESDA/JEDEC JS-001 | ESD | 5 | kV |

Electrical & Optical Characteristics (Ta=25°C)

| Deremeter | Symbol | | Values | | l loit | Test |
|----------------------------|---------------------|--------------------|--------|--------------------|--------|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Condition |
| Input Voltage | V _{DD} | 4.5 | 5.0 | 5.5 | V | |
| R/G/B Output Drive Current | lo | 0.71 | 3.63 | 12 | mA | V _{ds} =1V |
| | VIH | 0.7V _{DD} | | | V | |
| Input Voltage Level | VIL | | | 0.3V _{DD} | V | |
| Current Deviation | dlo | | ±3 | ±5 | % | V _{ds} =1V; I ₀ =12mA |
| Dynamic IC Consumption | I _{dd.dyn} | | | 1 | mA | Data input, light off |
| Quiescent Current | I _{DD} | | | 5 | uA | No data in, light off |



| | | (| e ., .p | - | | 1 | |
|---------------------|---|----------------|---------|--------|------|---------|-------------------------|
| Parameter | | Symbol | | Values | | Unit | Test |
| Falameter | | Symbol | Min. | Тур. | Max. | Onit | Condition |
| | R | | | 70 | | | I⊧=3.63mA |
| | G | | | 310 | | une and | I _F =3.63mA |
| Luminous Intensity | В | l _V | | 65 | | mcd | I⊧=3.63mA |
| | W | | 320 | 460 | 630 | | I _F =10.89mA |
| | R | | | 624 | | | l⊧=3.63mA |
| Dominant Wavelength | G | λ_{D} | | 528 | | nm | l⊧=3.63mA |
| | В | | | 469 | | | I _F =3.63mA |
| Colour Coordinate | х | | | 0.2200 | | | L-10.80mA |
| | Y | | | 0.2783 | | | l⊧=10.89mA |
| Viewing Angle | | 2 θ 1/2 | | 120 | | deg | I⊧=10.89mA |

Electrical & Optical Characteristics (Ta=25°C, V_{DD}=5V)

1. Luminous Intensity: ±10%mcd, Dominant Wavelength: ±1.0nm, Color Coordinate: ±0.005

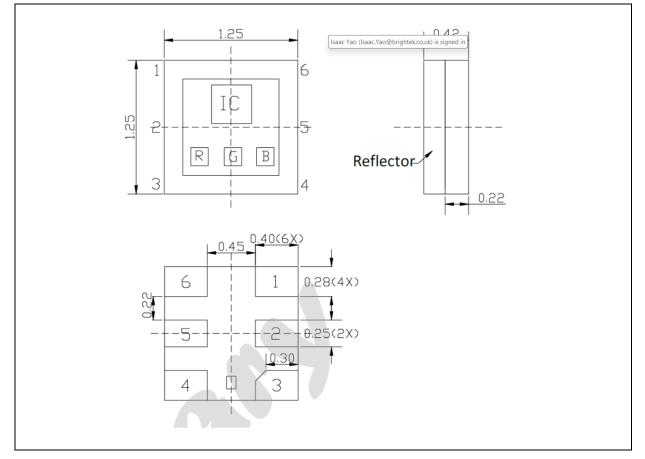
Switching Characteristics (Ta=25°C)

| Daramatar | Symbol | | Values | | Unit | Test |
|---------------------------|------------------|------|--------|------|------|------------------------------|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Condition |
| Rate of Data Signal | F _{DIN} | | 1 | 1.3 | MHz | V _{DD} =5V |
| Oscillation Frequency | Fosc | | 8 | | MHz | V _{DD} =5V |
| PWM Frequency | F _{PWM} | | 4 | | KHZ | |
| Output Current Conversion | Tr | | | 60 | ns | V _{ds} =1.5V; |
| Time | T _f | | | 60 | ns | I ₀ =12mA |
| Transmission Delay Time | T _{pzl} | | | 200 | ns | $D_{IN} \rightarrow D_{OUT}$ |



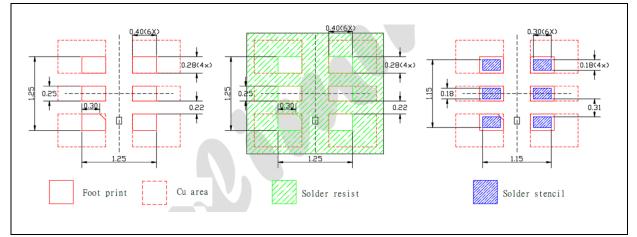
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm, unless otherwise noted.

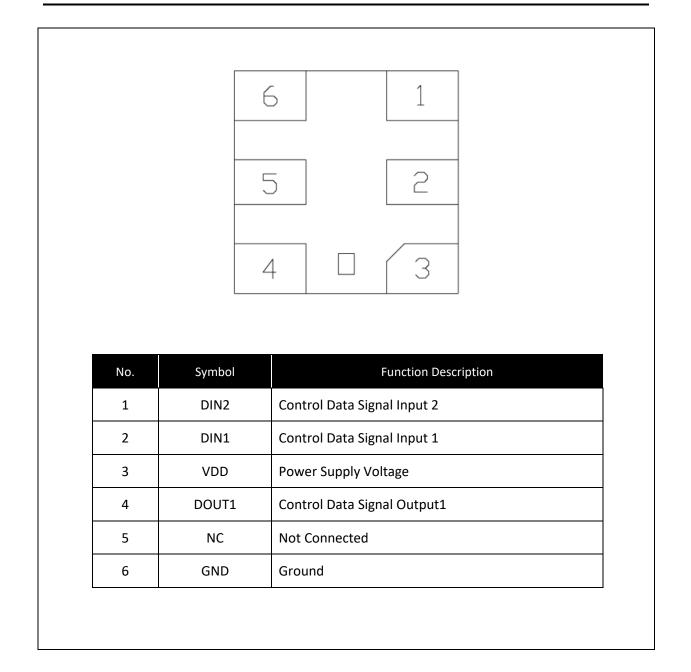
Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ± 0.1 mm with angle tolerance $\pm 0.5^{\circ}$.



PIN CONFIGURATION:



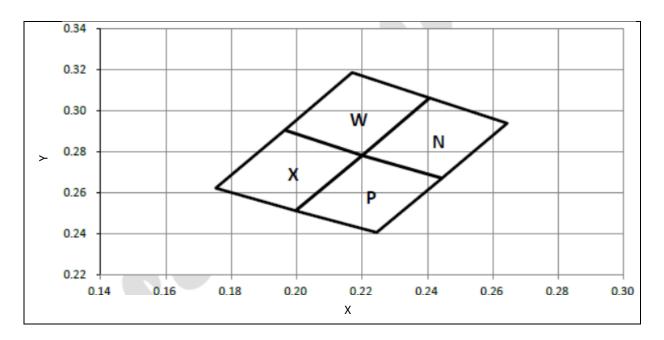


BINNING GROUPS:

| Code | Min. | Max. | Unit |
|------|------|------|------|
| 17 | 320 | 400 | |
| 18 | 400 | 500 | mcd |
| 19 | 500 | 630 | |

Luminous Intensity Classifications (I_F=10.89mA, V_{DD}=5V, T_a=25°C):

CIE CHROMATICITY DIAGRAM:



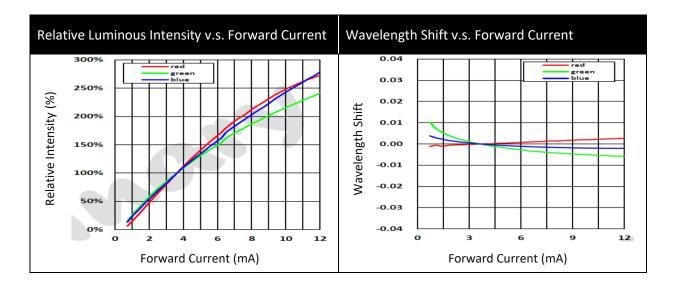
Chromaticity Coordinates Classifications:

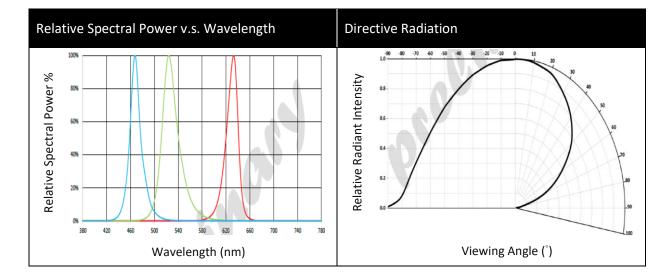
| | 1 | L | 2 | | 3 | 3 | 4 | | |
|---|--------|--------|--------|--------|--------|--------|--------|--------|--|
| | Х | Y | Х | Y | Х | Y | Х | Y | |
| w | 0.1963 | 0.2907 | 0.2169 | 0.3188 | 0.2406 | 0.3064 | 0.2200 | 0.2783 | |
| N | 0.2200 | 0.2783 | 0.2406 | 0.3064 | 0.2643 | 0.2940 | 0.2444 | 0.2672 | |
| х | 0.1963 | 0.2907 | 0.1752 | 0.2624 | 0.1996 | 0.2513 | 0.2200 | 0.2783 | |
| Р | 0.2200 | 0.2783 | 0.1996 | 0.2513 | 0.2244 | 0.2407 | 0.2444 | 0.2672 | |

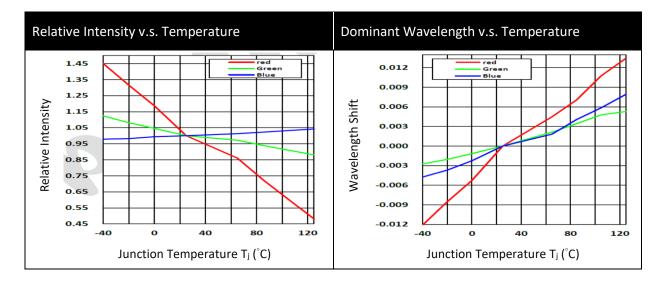
1. Tolerance Luminous Intensity: ±10%mcd, Color Coordinate: ±0.005



ELECTRO-OPTICAL CHARACTERISTICS:

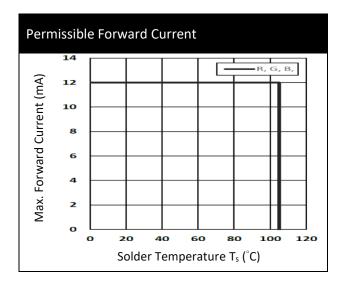








ELECTRO-OPTICAL CHARACTERISTICS:



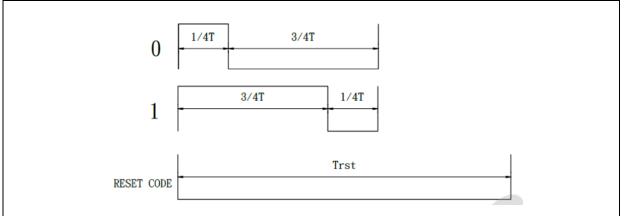


Function Description:

| RGB Gain Setting | RGB Output (mA) | | |
|------------------|-----------------|----|-------|
| 0 | 0.71 | 10 | 6.47 |
| 1 | 1.07 | 11 | 6.83 |
| 2 | 1.46 | 12 | 7.22 |
| 3 | 1.81 | 13 | 7.60 |
| 4 | 2.18 | 14 | 7.96 |
| 5 | 2.55 | 15 | 8.34 |
| 6 | 2.94 | 16 | 8.73 |
| 7 | 3.30 | 17 | 9.08 |
| 8 | 3.63 | 18 | 9.40 |
| 9 | 3.98 | 19 | 9.77 |
| Α | 4.36 | 1A | 10.15 |
| В | 4.74 | 1B | 10.54 |
| С | 5.11 | 1C | 10.90 |
| D | 5.48 | 1D | 11.27 |
| E | 5.87 | 1E | 11.67 |
| F | 6.24 | 1F | 12.00 |

1. Current Gain (Dimming Level) Regulation

2. Timing Wave Form:



3. Data Transfer Time:

| Item | Description | Typical | Tolerance |
|------|------------------------------|---------|-----------|
| тон | 0 code, high voltage time | 0.24µs | ±10% |
| TOL | 0 code, low voltage time | 0.48µs | ±10% |
| T1H | 1 code, high voltage time | 0.48µs | ±10% |
| T1L | 1 code, low voltage time | 0.24µs | ±10% |
| Trst | reset time, low voltage time | ≥80µs | - |



4. Composition of 48bit Data:

| R15 | R14 | | R1 | RO | G15 | G14 | | G1 | G0 | B15 | B14 | | B1 | BO |
|--|--|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| LED brightness 48bits data structure, high bit is sent first, and data is sent in the order of RGB | | | | | | | | | | | | | | |
| GR4 | GR3 | GR2 | GR1 | GR0 | GG4 | GG3 | GG2 | GG1 | GG0 | GB4 | GB3 | GB2 | GB1 | GB0 |
| RGB g | RGB gain 15bits data structure, high bit is sent first, and data is sent in the order of RGB | | | | | | | | | | | | | |

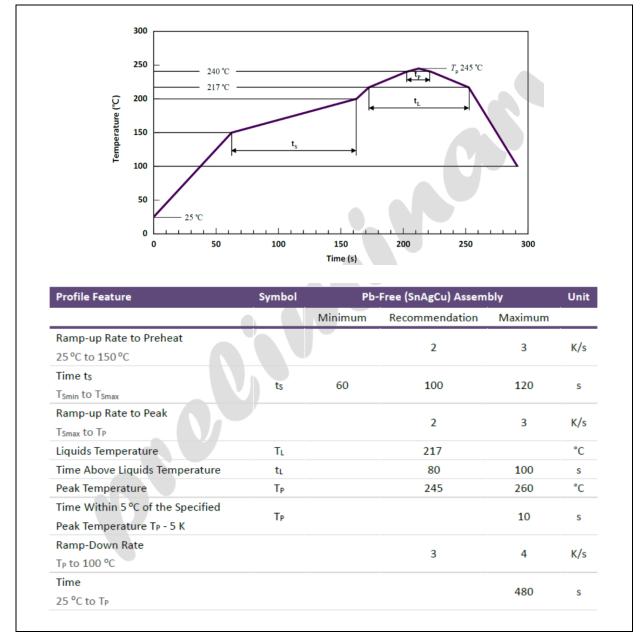
5. Data transmission method:

| | Data Frame | Da | ta Frame | | |
|----------|---------------|------------------|----------|---------------|--------------|
| | | RESET Code ≥80us | | | |
| LED1 DIN | LED1 (48bits) | LED2 (48bits) | | LEDN (48bits) | RGB (15bits) |
| LED2 DIN | | LED2 (48bits) | | LEDN (48bits) | RGB (15bits) |
| LEDN DIN | | | | LEDN (48bits) | RGB (15bits) |



RECOMMENDED SOLDERING PROFILE:

Lead-free Solder IR Reflow:



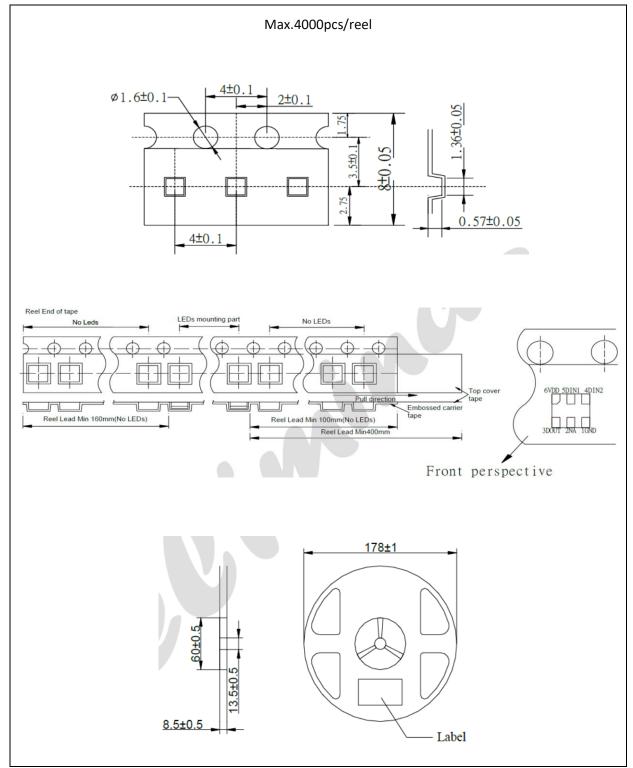
Note:

- 1. We recommend the reflow temperature 240°C (±5°C). The maximum soldering temperature should be limited to 260°C.
- 2. Maxima reflow soldering: 2 times.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:



PRECAUTIONS OF USE:



Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent stored at R.H.<10% and apply baking before use.

Over-Current Proof:

Must apply resistors for protection otherwise slight voltage shift will cause big current change and burnout will happen.

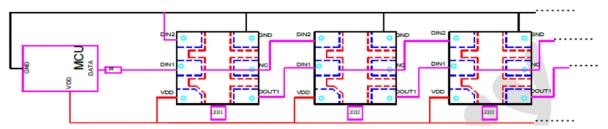
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

60±3°C x 6hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Typical Application Circuit:



When the first LED is connected to the MCU, a resistance R is needed in series between its signal input line and the MCU. The size of R depends on the number of cascade beads. The more cascades, the smaller resistance R is used. It is generally recommended that the value be between 100-1K. Usually the recommended value is around 300Ω . To make the LEDs work more stably, a parallel capacitor is needed between VDD and GND of each LED.

Cleaning:

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Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.



REVISION RECORD:

| Version | Date | Summary of Revision |
|---------|------------|---------------------|
| A1.0 | 27/03/2024 | Datasheet set-up. |